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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

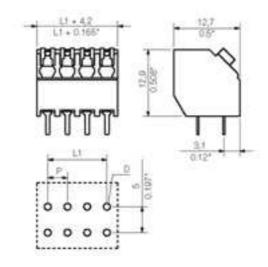
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China















General ordering data	
Order No.	1885230000
Part designation	LSF-SMT3.50/7/135 1.5
Version	PCB terminal, Push In, Reflow solder connection,
	Clamping range, max.: 1.5 mm², Pitch: 3.50 mm,
	No. of poles: 7, 135°, Tube
EAN	4032248490103
Qty.	21 pc(s).

Product family	System LS
Conductor connection system	Push In
Fitted to PCB	Reflow solder connection
Outgoing direction of conductor	135°
Pitch	3.5 mm
Pitch in inch	0.138 inch
No. of poles	7
Fitted by customer	no
No. of rows	1
Solder pin length	1.5 mm
Dia. of fitting hole	1.1 mm
Fitting hole tolerance	+ 0.1 mm
No. of solder pins per pole	2
Stripping length	8 mm



System parameters	
L1 in mm	21 mm
L1 in inch	0.827 inch
Electric shock protection to DIN VDE 0470	IP 20
Electric shock protection to DIN VDE 0470	Safe from finger touch
Electric shock protection to Birt VBE 0470	Cale non inger touch
Material data	
Insulating material	LCP GF
Colour	black
colour chart	Similar to RAL 9011
Insulating material group	Illa
Flammability class UL 94	V-0
CTI	>= 175
Contact base material	Copper alloy
Contact surface	tinned
Storage temperature, min.	-25 °C
Storage temperature, max.	55 °C
Connectable conductors	0.40
Clamping range, min.	0.13 mm <sup>2</sup>
Clamping range, max.	1.5 mm <sup>2</sup>
AWG, min.	24
AWG, max.	16
O.D. of conductor insulation, max.	2.9 mm
Solid, min. H05(07) V-U	0.2 mm <sup>2</sup>
Solid, max. H05(07) V-U	1.5 mm²
Flexible, min. H05(07) V-K	0.2 mm²
Flexible, max. H05(07) V-K	1.5 mm²
With wire and farrula, acc. to DIN 46 228/1, min.	0.25 mm <sup>2</sup>
With wire end ferrule, acc. to DIN 46 228/1, max.	1.5 mm <sup>2</sup> 0.25 mm <sup>2</sup>
w. plastic collar ferrule, DIN 46228 pt 4, min. w. plastic collar ferrule, DIN 46228 pt 4, max.	0.75 mm <sup>2</sup>
w. plastic collar lerrule, DIN 40220 pt 4, max.	0.75 11111
DIN IEC rating data	
Rated current, min. No. pins (Tu=20°C)	17.5 A
Rated current, max. No. pins (Tu=20°C)	16 A
Rated current, min. No. pins(Tu=40°C)	17.5 A
Rated current, max. No. pins (Tu=40°C)	14 A
Rated voltage for overvoltage class/pollution	320 V
severity II/2	
Rated voltage for overvoltage class/pollution	160 V
severity III/2	
Rated voltage for overvoltage class/pollution	160 V
severity III/3	
Rated impulse withstand voltage for overvoltage	2.5 kV
class/pollution severity II/2	
Rated impulse withstand voltage for overvoltage	2.5 kV
class/pollution severity III/2	
Rated impulse withstand voltage for overvoltage	2.5 kV
class/pollution severity III/3	
Short-time withstand current resistance	3 x 1s with 80 A



300 V
10 A
24
16
300 V
10 A
24
16

## Annrovals

Approvals institutes



Classifications

eClass 5.1 27-26-11-01

## Similar products

1885650000	LSF-SMT3.50/2/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 2, 135°, Tube
1887340000	LSF-SMT3.5/2/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 2, 135°, Tape
1885180000	LSF-SMT3.50/2/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 2, 135°, Tube
1887550000	LSF-SMT3.5/2/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 2, 135°, Tape
1885660000	LSF-SMT3.50/3/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 3, 135°, Tube
1887350000	LSF-SMT3.5/3/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 3, 135°, Tape
1885190000	LSF-SMT3.50/3/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 3, 135°, Tube
1887560000	LSF-SMT3.5/3/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 3, 135°, Tape
1885670000	LSF-SMT3.50/4/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 4, 135°, Tube
1887360000	LSF-SMT3.5/4/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 4, 135°, Tape
1885200000	LSF-SMT3.50/4/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 4, 135°, Tube
1887580000	LSF-SMT3.5/4/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 4, 135°, Tape



1885680000	LSF-SMT3.50/5/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 5, 135°, Tube
1887460000	LSF-SMT3.5/5/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 5, 135°, Tape
1885210000	LSF-SMT3.50/5/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 5, 135°, Tube
1887630000	LSF-SMT3.5/5/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 5, 135°, Tape
1885690000	LSF-SMT3.50/6/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 6, 135°, Tube
1887470000	LSF-SMT3.5/6/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 6, 135°, Tape
1885220000	LSF-SMT3.50/6/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1887640000	LSF-SMT3.5/6/135 1.5R	max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 6, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 6, 135°, Tape
1885700000	LSF-SMT3.50/7/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 7, 135°, Tube
1887480000	LSF-SMT3.5/7/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 7, 135°, Tape
1887650000	LSF-SMT3.5/7/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 7, 135°, Tape
1885710000	LSF-SMT3.50/8/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 8, 135°, Tube
1887490000	LSF-SMT3.5/8/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 8, 135°, Tape
1885240000	LSF-SMT3.50/8/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 8, 135°, Tube
1887660000	LSF-SMT3.5/8/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 8, 135°, Tape
1885720000	LSF-SMT3.50/9/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 9, 135°, Tube
1887500000	LSF-SMT3.5/9/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 9, 135°, Tape
1885250000	LSF-SMT3.50/9/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 9, 135°, Tube
1887670000	LSF-SMT3.5/9/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 9, 135°, Tape
1885730000	LSF-SMT3.50/10/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 10, 135°, Tube
1887510000	LSF-SMT3.5/10/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
400500000	LOE OMTO FOLIO IA DE	max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 10, 135°, Tape
1885260000	LSF-SMT3.50/10/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 10, 135°, Tube
1887680000	LSF-SMT3.5/10/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 10, 135°, Tape
1885740000	LSF-SMT3.50/11/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 11, 135°, Tube
1887520000	LSF-SMT3.5/11/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
1005070000	LOT OMT3 F0/44/435 4 F	max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 11, 135°, Tape
1885270000	LSF-SMT3.50/11/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> , Pitch: 3.50 mm, No. of poles: 11, 135°, Tube

188769000 LSF-SMT3.5/11/135 1.5R PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 11, 135°, Tape PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 12, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 12, 135°, Tape PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 12, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 12, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 12, 135°, Tape PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube	ge, ge, ge, ge,
1885750000 LSF-SMT3.50/12/135 3.5 PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 12, 135°, Tube 1887530000 LSF-SMT3.5/12/135 3.5R PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 12, 135°, Tape 1885280000 LSF-SMT3.50/12/135 1.5 PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 12, 135°, Tube 1887700000 LSF-SMT3.50/13/135 1.5R PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 12, 135°, Tape 1885760000 LSF-SMT3.50/13/135 3.5 PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube 1885290000 LSF-SMT3.50/13/135 1.5 PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube	ge, ge, ge,
1887530000 LSF-SMT3.5/12/135 3.5R PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 12, 135°, Tape  1885280000 LSF-SMT3.50/12/135 1.5 PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 12, 135°, Tube  1887700000 LSF-SMT3.5/12/135 1.5R PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 12, 135°, Tape  1885760000 LSF-SMT3.50/13/135 3.5 PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube  1885290000 LSF-SMT3.50/13/135 1.5 PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube	ge, ge, ge,
max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 12, 135°, Tape  PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 12, 135°, Tube  RCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 12, 135°, Tube  RCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 12, 135°, Tape  RCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube  RCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube	ge, ge, ge,
max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 12, 135°, Tube  PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 12, 135°, Tape  1885760000 LSF-SMT3.50/13/135 3.5 PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube  1885290000 LSF-SMT3.50/13/135 1.5 PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube	ge, ge,
max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 12, 135°, Tape  1885760000 LSF-SMT3.50/13/135 3.5 PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube  1885290000 LSF-SMT3.50/13/135 1.5 PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube	ge,
1885760000 LSF-SMT3.50/13/135 3.5 PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube	
1885290000 LSF-SMT3.50/13/135 1.5 PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube	је,
max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube	<b>,</b>
1885770000 I SE-SMT3 50/14/135 3.5 PCR terminal Push in Reflow solder connection. Clamping ran	
max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 14, 135°, Tube	је,
1885300000 LSF-SMT3.50/14/135 1.5 PCB terminal, Push In, Reflow solder connection, Clamping ran	ge,
max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 14, 135°, Tube	
1885780000 LSF-SMT3.50/15/135 3.5 PCB terminal, Push In, Reflow solder connection, Clamping ran	је,
max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 15, 135°, Tube	
1885310000 LSF-SMT3.50/15/135 1.5 PCB terminal, Push In, Reflow solder connection, Clamping ran	је,
max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 15, 135°, Tube 1885790000 LSF-SMT3.50/16/135 3.5 PCB terminal, Push In, Reflow solder connection, Clamping ran	70
max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 16, 135°, Tube	je,
1885320000 LSF-SMT3.50/16/135 1.5 PCB terminal, Push In, Reflow solder connection, Clamping ran	ae.
max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 16, 135°, Tube	, - ,
1885800000 LSF-SMT3.50/17/135 3.5 PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 17, 135°, Tube	је,
1885330000 LSF-SMT3.50/17/135 1.5 PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 17, 135°, Tube	је,
1885810000 LSF-SMT3.50/18/135 3.5 PCB terminal, Push In, Reflow solder connection, Clamping ran	ge,
max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 18, 135°, Tube	
1885340000 LSF-SMT3.50/18/135 1.5 PCB terminal, Push In, Reflow solder connection, Clamping ran	је,
max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 18, 135°, Tube	
1885820000 LSF-SMT3.50/19/135 3.5 PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 19, 135°, Tube	је,
1885350000 LSF-SMT3.50/19/135 1.5 PCB terminal, Push In, Reflow solder connection, Clamping ran	ar Ar
max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 19, 135°, Tube	<i>j</i> C,
1885830000 LSF-SMT3.50/20/135 3.5 PCB terminal, Push In, Reflow solder connection, Clamping ran	ge,
max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 20, 135°, Tube	
1885360000 LSF-SMT3.50/20/135 1.5 PCB terminal, Push In, Reflow solder connection, Clamping ran	је,
max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 20, 135°, Tube	
1885840000 LSF-SMT3.50/21/135 3.5 PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 21, 135°, Tube	је,
1885370000 LSF-SMT3.50/21/135 1.5 PCB terminal, Push In, Reflow solder connection, Clamping ran	ne
max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 21, 135°, Tube	<i>j</i> C,
1885850000 LSF-SMT3.50/22/135 3.5 PCB terminal, Push In, Reflow solder connection, Clamping ran max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 22, 135°, Tube	је,
1885380000 LSF-SMT3.50/22/135 1.5 PCB terminal, Push In, Reflow solder connection, Clamping ran	je.
max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 22, 135°, Tube	, · ,
1885860000 LSF-SMT3.50/23/135 3.5 PCB terminal, Push In, Reflow solder connection, Clamping ran	ge,
max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 23, 135°, Tube	

1885390000	LSF-SMT3.50/23/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 23, 135°, Tube
1885870000	LSF-SMT3.50/24/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 24, 135°, Tube
1885400000	LSF-SMT3.50/24/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm <sup>2</sup> . Pitch: 3.50 mm. No. of poles: 24, 135°. Tube

